# 74HC4040; 74HCT4040

### 12-stage binary ripple counter

Rev. 6 — 8 June 2020

**Product data sheet** 

### 1. General description

The 74HC4040; 74HCT4040 is a 12-stage binary ripple counter with a clock input  $(\overline{CP})$ , an overriding asynchronous master reset input (MR) and twelve parallel outputs (Q0 to Q11). The counter advances on the HIGH-to-LOW transition of  $\overline{CP}$ . A HIGH on MR clears all counter stages and forces all outputs LOW, independent of the state of  $\overline{CP}$ . Each counter stage is a static toggle flip-flop. Inputs include clamp diodes that enable the use of current limiting resistors to interface inputs to voltages in excess of  $V_{CC}$ .

#### 2. Features and benefits

- Wide supply voltage range from 2.0 V to 6.0 V
- CMOS low power dissipation
- · High noise immunity
- · Latch-up performance exceeds 100 mA per JESD 78 Class II Level B
- Complies with JEDEC standards:
  - JESD8C (2.7 V to 3.6 V)
  - JESD7A (2.0 V to 6.0 V)
- Input levels:
  - For 74HC4040: CMOS level
  - For 74HCT4040: TTL level
- ESD protection:
  - HBM JESD22-A114F exceeds 2000 V
  - MM JESD22-A115-A exceeds 200 V
- Multiple package options
- Specified from -40 °C to +85 °C and from -40 °C to +125 °C

### 3. Applications

- Frequency dividing circuits
- · Time delay circuits
- Control counters

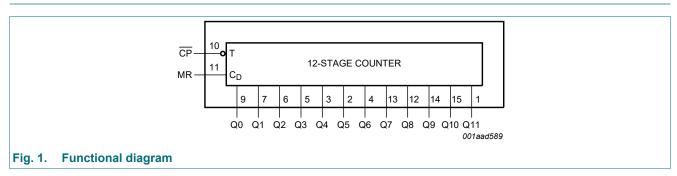


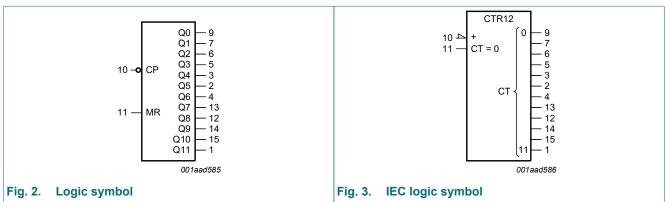
### 4. Ordering information

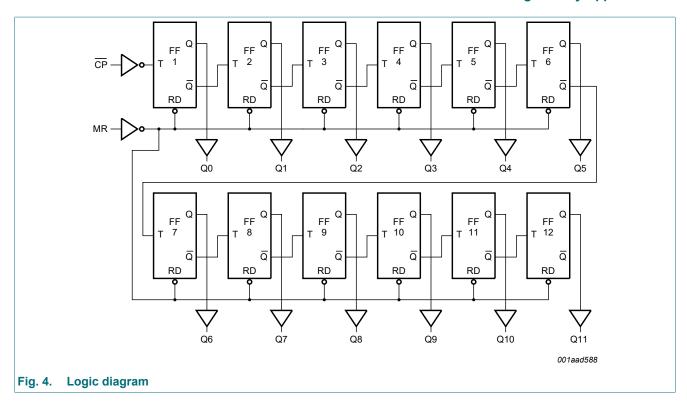
**Table 1. Ordering information** 

Type number	Package			
	Temperature range	Name	Description	Version
74HC4040D	-40 °C to +125 °C	SO16	plastic small outline package; 16 leads;	SOT109-1
74HCT4040D			body width 3.9 mm	
74HCT4040DB	-40 °C to +125 °C	SSOP16	plastic shrink small outline package; 16 leads; body width 5.3 mm	SOT338-1
74HC4040PW	-40 °C to +125 °C	TSSOP16	plastic thin shrink small outline package;	SOT403-1
74HCT4040PW			16 leads; body width 4.4 mm	
74HC4040BQ	-40 °C to +125 °C	DHVQFN16	plastic dual in-line compatible	SOT763-1
74HCT4040BQ			thermal enhanced very thin quad flat package; no leads; 16 terminals; body 2.5 × 3.5 × 0.85 mm	

### 5. Functional diagram

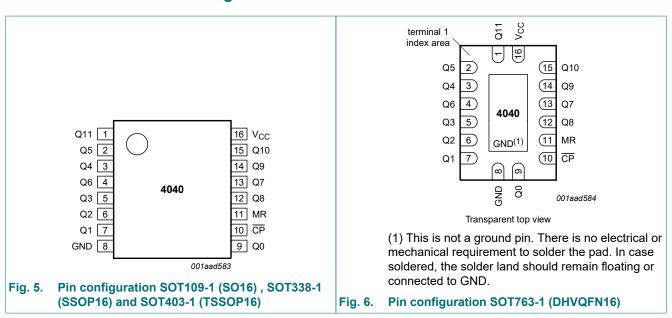






### 6. Pinning information

#### 6.1. Pinning



### 6.2. Pin description

Table 2. Pin description

Symbol	Pin	Description
Q11	1	output 11
Q5	2	output 5
Q4	3	output 4
Q6	4	output 6
Q3	5	output 3
Q2	6	output 2
Q1	7	output 1
GND	8	ground (0 V)
Q0	9	output 0
CP	10	clock input (HIGH-to-LOW, edge-triggered)
MR	11	master reset input (active HIGH)
Q8	12	output 8
Q7	13	output 7
Q9	14	output 9
Q10	15	output 10
V <sub>CC</sub>	16	positive supply voltage

### 7. Functional description

#### 7.1. Function table

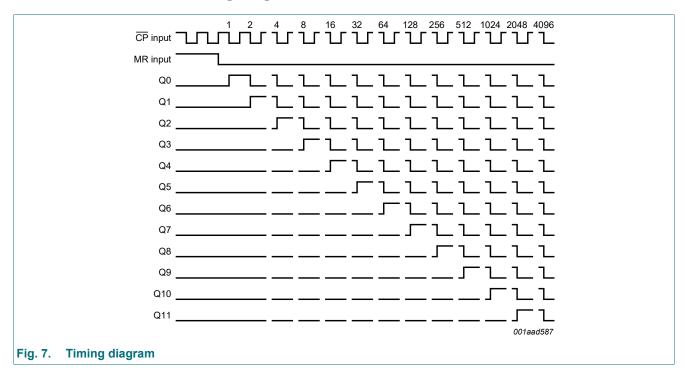
#### **Table 3. Function table**

 $H = HIGH \ voltage \ level; \ L = LOW \ voltage \ level; \ X = don't \ care;$ 

 $\uparrow$  = LOW-to-HIGH clock transition;  $\downarrow$  = HIGH-to-LOW clock transition.

Input		Output
СР	MR	Q0 to Q11
<b>↑</b>	L	no change
$\downarrow$	L	count
X	Н	L

#### 7.2. Timing diagram



### 8. Limiting values

#### **Table 4. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	supply voltage		-0.5	+7	V
I <sub>IK</sub>	input clamping current	$V_I < -0.5 \text{ V or VI} > V_{CC} + 0.5 \text{ V}$ [1]	-	±20	mA
I <sub>OK</sub>	output clamping current	$V_I < -0.5 \text{ V or } V_I > V_{CC} + 0.5 \text{ V}$ [1]	-	±20	mA
Io	output current	-0.5 V < V <sub>O</sub> < V <sub>CC</sub> + 0.5 V	-	±25	mA
I <sub>CC</sub>	supply current		-	±50	mA
$I_{GND}$	ground current		-	±50	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
P <sub>tot</sub>	total power dissipation	$T_{amb} = -40  ^{\circ}\text{C} \text{ to } +125  ^{\circ}\text{C}$ [2]	-	500	mW

<sup>[1]</sup> The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

For SOT338-1 (SSOP16) package: Ptot derates linearly with 8.5 mW/K above 91 °C.

For SOT403-1 (TSSOP16) package:  $P_{tot}$  derates linearly with 8.5 mW/K above 91 °C.

For SOT763-1 (DHVQFN16) package: Ptot derates linearly with 11.2 mW/K above 106 °C.

<sup>[2]</sup> For SOT109-1 (SO16) package: Ptot derates linearly with 12.4 mW/K above 110 °C.

### 9. Recommended operating conditions

#### Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V)

Symbol	Parameter	Conditions	7	4HC404	0	74	4HCT404	10	Unit
			Min	Тур	Max	Min	Тур	Max	
V <sub>CC</sub>	supply voltage		2.0	5.0	6.0	4.5	5.0	5.5	V
VI	input voltage		0	-	V <sub>CC</sub>	0	-	V <sub>CC</sub>	V
Vo	output voltage		0	-	V <sub>CC</sub>	0	-	V <sub>CC</sub>	V
T <sub>amb</sub>	ambient temperature		-40	+25	+125	-40	+25	+125	°C
Δt/ΔV	input transition rise and fall rate	V <sub>CC</sub> = 2.0 V	-	-	625	-	-	-	ns/V
		V <sub>CC</sub> = 4.5 V	-	1.67	139	-	1.67	139	ns/V
		V <sub>CC</sub> = 6.0 V	-	-	83	-	-	-	ns/V

### 10. Static characteristics

#### **Table 6. Static characteristics**

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		25 °C		-40 °C t	o +85 °C	-40 °C to	+125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
74HC40	40				'					
$V_{IH}$	HIGH-level	V <sub>CC</sub> = 2.0 V	1.5	1.2	-	1.5	-	1.5	-	V
	input voltage	V <sub>CC</sub> = 4.5 V	3.15	2.4	-	3.15	-	3.15	-	V
		V <sub>CC</sub> = 6.0 V	4.2	3.2	-	4.2	-	4.2	-	V
$V_{IL}$	LOW-level	V <sub>CC</sub> = 2.0 V	-	0.8	0.5	-	0.5	-	0.5	V
	input voltage	V <sub>CC</sub> = 4.5 V	-	2.1	1.35	-	1.35	-	1.35	V
		V <sub>CC</sub> = 6.0 V	-	2.8	1.8	-	1.8	-	1.8	V
V <sub>OH</sub>	HIGH-level	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>								
	output voltage	I <sub>O</sub> = -20 μA; V <sub>CC</sub> = 2.0 V	1.9	2.0	-	1.9	-	1.9	-	V
		I <sub>O</sub> = -20 μA; V <sub>CC</sub> = 4.5 V	4.4	4.5	-	4.4	-	4.4	-	V
		I <sub>O</sub> = -20 μA; V <sub>CC</sub> = 6.0 V	5.9	6.0	-	5.9	-	5.9	-	V
		I <sub>O</sub> = -4.0 mA; V <sub>CC</sub> = 4.5 V	3.98	4.32	-	3.84	-	3.7	-	V
		I <sub>O</sub> = -5.2 mA; V <sub>CC</sub> = 6.0 V	5.48	5.81	-	5.34	-	5.2	-	V
$V_{OL}$	LOW-level	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>								
	output voltage	$I_O = 20 \mu A; V_{CC} = 2.0 V$	-	0	0.1	-	0.1	-	0.1	V
		I <sub>O</sub> = 20 μA; V <sub>CC</sub> = 4.5 V	-	0	0.1	-	0.1	-	0.1	V
		I <sub>O</sub> = 20 μA; V <sub>CC</sub> = 6.0 V	-	0	0.1	-	0.1	-	0.1	V
		I <sub>O</sub> = 4.0 mA; V <sub>CC</sub> = 4.5 V	-	0.15	0.26	-	0.33	-	0.4	V
		I <sub>O</sub> = 5.2 mA; V <sub>CC</sub> = 6.0 V	-	0.16	0.26	-	0.33	-	0.4	V
l <sub>l</sub>	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 6.0 \text{ V}$	-	-	±0.1	-	±1.0	-	±1.0	μΑ
I <sub>CC</sub>	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 6.0 \text{ V}$	-	-	8.0	-	80	-	160	μΑ
Cı	input capacitance		-	3.5	-					pF

Symbol	Parameter	Conditions		25 °C		-40 °C t	o +85 °C	-40 °C to	+125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
74HCT4	040									
V <sub>IH</sub>	HIGH-level input voltage	V <sub>CC</sub> = 4.5 V to 5.5 V	2.0	1.6	-	2.0	-	2.0	-	V
V <sub>IL</sub>	LOW-level input voltage	V <sub>CC</sub> = 4.5 V to 5.5 V	-	1.2	0.8	-	0.8	-	0.8	V
V <sub>OH</sub>	HIGH-level	$V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 4.5 V$								
	output voltage	I <sub>O</sub> = -20 μA	4.4	4.5	-	4.4	-	4.4	-	V
		I <sub>O</sub> = -4 mA	3.98	4.32	-	3.84	-	3.7	-	V
V <sub>OL</sub>	LOW-level	$V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 4.5 V$								
	output voltage	Ι <sub>Ο</sub> = 20 μΑ	-	0	0.1	-	0.1	-	0.1	V
		I <sub>O</sub> = 4.0 mA	-	0.15	0.26	-	0.33	-	0.4	V
l <sub>l</sub>	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 5.5 \text{ V}$	-	-	±0.1	-	±1.0	-	±1.0	μA
I <sub>CC</sub>	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 5.5 \text{ V}$	-	-	8.0	-	80	-	160	μΑ
Δl <sub>CC</sub>	additional supply current	per input pin; $V_I = V_{CC} - 2.1 \text{ V}$ ; $I_O = 0 \text{ A}$ ; other inputs at $V_{CC}$ or GND; $V_{CC} = 4.5 \text{ V}$ to 5.5 V								
		pin CP	-	85	306	-	383	-	417	μΑ
		pin MR	-	110	396	-	495	-	539	μΑ
Cı	input capacitance		-	3.5	-	-	-	-	-	pF

## 11. Dynamic characteristics

**Table 7. Dynamic characteristics** 

GND (ground = 0 V);  $C_L$  = 50 pF unless otherwise specified; for test circuit, see Fig. 9.

Symbol	Parameter	Conditions		25 °C		-40 °C to	o +85 °C	-40 °C to	+125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	1
74HC40	40					l	I	ı	1	
t <sub>pd</sub>	propagation	CP to Q0; see Fig. 8         [1]								
	delay	V <sub>CC</sub> = 2.0 V	-	47	150	-	190	-	225	ns
		V <sub>CC</sub> = 4.5 V	-	17	30	-	38	-	45	ns
		V <sub>CC</sub> = 5.0 V; C <sub>L</sub> = 15 pF	-	14	-	-	-	-	-	ns
		V <sub>CC</sub> = 6.0 V	-	14	26	-	33	-	38	ns
		Qn to Qn+1; see Fig. 8								
		V <sub>CC</sub> = 2.0 V	-	28	100	-	125	-	150	ns
		V <sub>CC</sub> = 4.5 V	-	10	20	-	25	-	30	ns
		V <sub>CC</sub> = 5.0 V; C <sub>L</sub> = 15 pF	-	8	-	-	-	-	-	ns
		V <sub>CC</sub> = 6.0 V	-	8	17	-	21	-	26	ns
t <sub>PHL</sub>	HIGH to LOW	MR to Qn; see Fig. 8								
	propagation delay	V <sub>CC</sub> = 2.0 V	-	61	185	-	230	-	280	ns
	delay	V <sub>CC</sub> = 4.5 V	-	22	37	-	46	-	56	ns
		V <sub>CC</sub> = 6.0 V	-	18	31	-	39	-	48	ns
t <sub>t</sub>	transition time	Qn; see Fig. 8 [2]								
		V <sub>CC</sub> = 2.0 V	-	19	75	-	95	-	110	ns
		V <sub>CC</sub> = 4.5 V	-	7	15	-	19	-	22	ns
		V <sub>CC</sub> = 6.0 V	-	6	13	-	16	-	19	ns
t <sub>W</sub>	pulse width	CP input, HIGH or LOW; see Fig. 8								
		V <sub>CC</sub> = 2.0 V	80	14	-	100	-	120	-	ns
		V <sub>CC</sub> = 4.5 V	16	5	-	20	-	24	-	ns
		V <sub>CC</sub> = 6.0 V	14	4	-	17	-	20	-	ns
		MR input, HIGH; see Fig. 8								
		V <sub>CC</sub> = 2.0 V	80	22	-	100	-	120	-	ns
		V <sub>CC</sub> = 4.5 V	16	8	-	20	-	24	-	ns
		V <sub>CC</sub> = 6.0 V	14	6	-	17	-	20	-	ns
t <sub>rec</sub>	recovery time	MR to $\overline{\text{CP}}$ ; see Fig. 8								
		V <sub>CC</sub> = 2.0 V	50	8	-	65	-	75	-	ns
		V <sub>CC</sub> = 4.5 V	10	3	-	13	-	15	-	ns
		V <sub>CC</sub> = 6.0 V	9	2	-	11	-	13	-	ns
f <sub>max</sub>	maximum	CP input; see Fig. 8								
	frequency	V <sub>CC</sub> = 2.0 V	6	27	-	4.8	-	4	-	MHz
		V <sub>CC</sub> = 4.5 V	30	82	-	24	-	20	-	MHz
		V <sub>CC</sub> = 5.0 V; C <sub>L</sub> = 15 pF	-	90	-	-	-	-	-	MHz
		V <sub>CC</sub> = 6.0 V	35	98	-	28	-	24	-	MHz

Symbol	Parameter	Conditions			25 °C		-40 °C to	o +85 °C	-40 °C to	+125 °C	Unit
				Min	Тур	Max	Min	Max	Min	Max	
C <sub>PD</sub>	power dissipation capacitance	$V_I$ = GND to $V_{CC}$	[3]	-	20	-	-	-	-	-	pF
<b>74HCT4</b>	040	,									
t <sub>pd</sub>	propagation	CP to Q0; see Fig. 8	[1]								
	delay	V <sub>CC</sub> = 4.5 V		-	19	40	-	50	-	60	ns
		V <sub>CC</sub> = 5.0 V; C <sub>L</sub> = 15 pF		-	16	-	-	-	-	-	ns
		Qn to Qn+1; see Fig. 8									
		V <sub>CC</sub> = 4.5 V		-	10	20	-	25	-	30	ns
		V <sub>CC</sub> = 5.0 V; C <sub>L</sub> = 15 pF		-	8	-	-	-	-	-	ns
t <sub>PHL</sub>	HIGH to LOW	MR to Qn; see Fig. 8									
	propagation delay	V <sub>CC</sub> = 4.5 V		-	23	45	-	56	-	68	ns
t <sub>t</sub>	transition time	Qn; see <u>Fig. 8</u>	[2]								
		V <sub>CC</sub> = 4.5 V		-	7	15	-	19	-	22	ns
t <sub>W</sub>	pulse width	CP input, HIGH or LOW; see Fig. 8									
		V <sub>CC</sub> = 4.5 V		16	7	-	20	-	24	-	ns
		MR input, HIGH; see Fig. 8									
		V <sub>CC</sub> = 4.5 V		16	6	-	20	-	24	-	ns
t <sub>rec</sub>	recovery time	MR to CP; see Fig. 8									
		V <sub>CC</sub> = 4.5 V		10	2	-	13	-	15	-	ns
f <sub>max</sub>	maximum	CP input; see Fig. 8									
	frequency	V <sub>CC</sub> = 4.5 V		30	72	-	24	-	20	-	MHz
		V <sub>CC</sub> = 5.0 V; C <sub>L</sub> = 15 pF		-	79	-	-	-	-	-	MHz
C <sub>PD</sub>	power dissipation capacitance	$V_I$ = GND to $V_{CC}$	[3]	-	20	-	-	-	-	-	pF

- [1] t<sub>pd</sub> is the same as t<sub>PHL</sub>, t<sub>PLH</sub>.
   [2] t<sub>t</sub> is the same as t<sub>THL</sub>, t<sub>TLH</sub>.
   [3] C<sub>PD</sub> is used to determine the dynamic power dissipation (P<sub>D</sub> in μW).

 $P_D = C_{PD} x V_{CC}^2 x f_i x N + \sum (C_L x V_{CC}^2 x f_o)$  where:

f<sub>i</sub> = input frequency in MHz;

f<sub>o</sub> = output frequency in MHz;

C<sub>L</sub> = output load capacitance in pF;

 $V_{CC}$  = supply voltage in V;

N = number of inputs switching;

 $\sum (C_L \times V_{CC}^2 \times f_o) = \text{sum of outputs.}$ 

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#### 11.1. Waveforms and test circuit

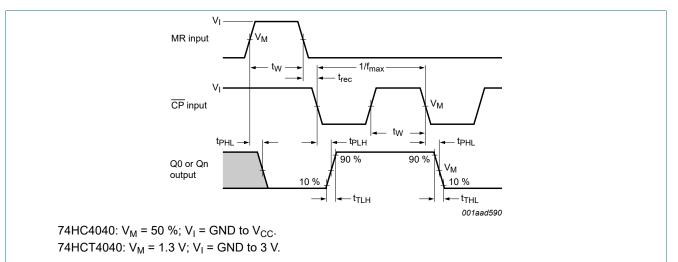
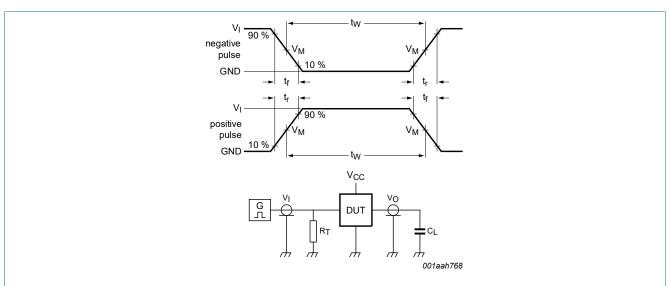


Fig. 8. Clock propagation delays, pulse width, transition times, maximum pulse frequency and master resets



Test data is given in Table 8.

Definitions test circuit:

 $R_{T}$  = termination resistance should be equal to output impedance  $Z_{o}$  of the pulse generator.

C<sub>L</sub> = load capacitance including jig and probe capacitance.

Fig. 9. Test circuit for measuring switching times

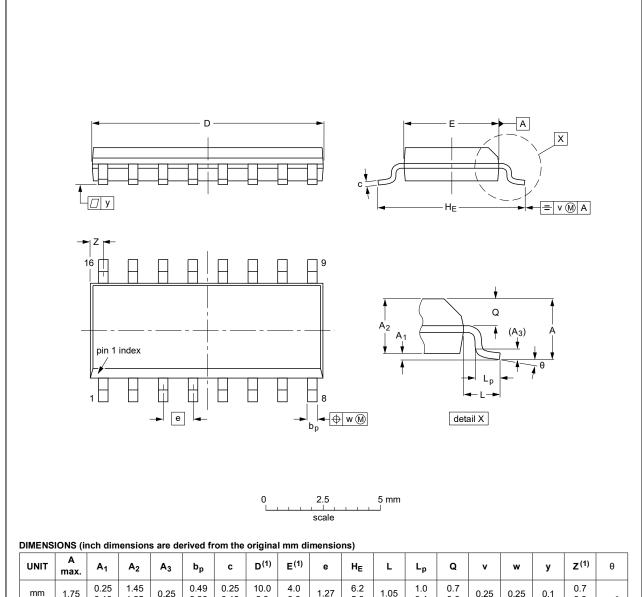
Table 8. Test data

Туре	Input		Load	Test
	VI	t <sub>r</sub> , t <sub>f</sub>	C <sub>L</sub>	
74HC4040	V <sub>CC</sub>	6.0 ns	15 pF, 50 pF	t <sub>PLH</sub> , t <sub>PHL</sub>
74HCT4040	3.0 V	6.0 ns	15 pF, 50 pF	t <sub>PLH</sub> , t <sub>PHL</sub>

### 12. Package outline

#### SO16: plastic small outline package; 16 leads; body width 3.9 mm

SOT109-1



UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	bp	С	D <sup>(1)</sup>	E <sup>(1)</sup>	е	HE	L	Lp	Q	v	w	у	Z <sup>(1)</sup>	θ
mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	10.0 9.8	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8°
inches	0.069	0.010 0.004	0.057 0.049	0.01		0.0100 0.0075	0.39 0.38	0.16 0.15	0.05	0.244 0.228	0.041	0.039 0.016	0.028 0.020	0.01	0.01	0.004	0.028 0.012	0°

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT109-1	076E07	MS-012				<del>99-12-27</del> 03-02-19

Fig. 10. Package outline SOT109-1 (SO16)

SSOP16: plastic shrink small outline package; 16 leads; body width 5.3 mm

SOT338-1

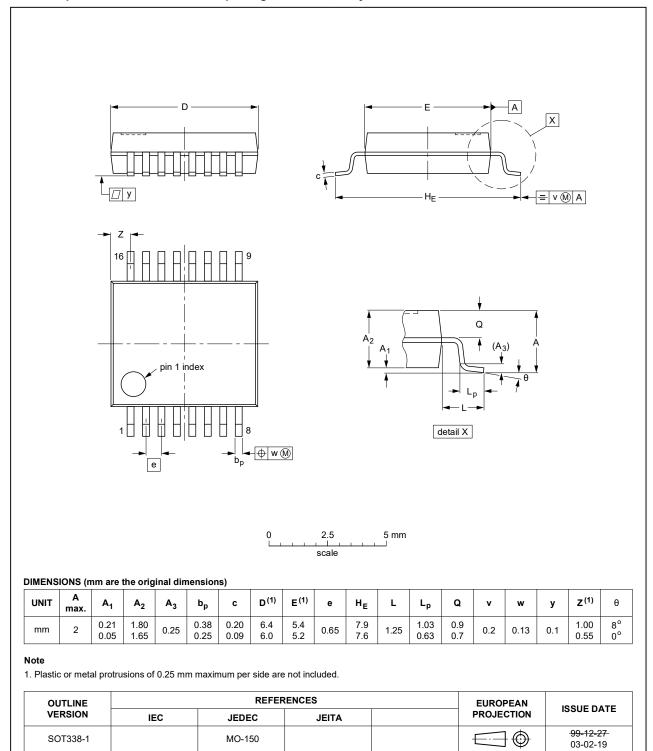
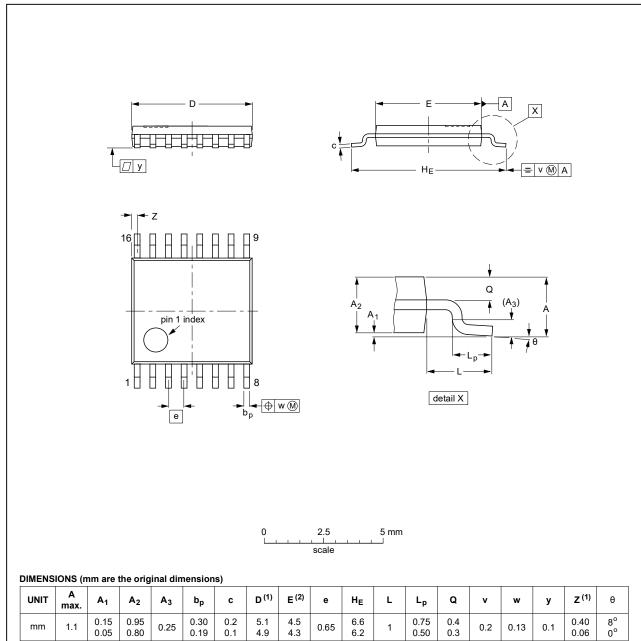


Fig. 11. Package outline SOT338-1 (SSOP16)

TSSOP16: plastic thin shrink small outline package; 16 leads; body width 4.4 mm

SOT403-1



#### Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN	ISSUE DATE
	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT403-1		MO-153				<del>99-12-27</del> 03-02-18

Fig. 12. Package outline SOT403-1 (TSSOP16)

DHVQFN16: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 16 terminals; body 2.5 x 3.5 x 0.85 mm SOT763-1

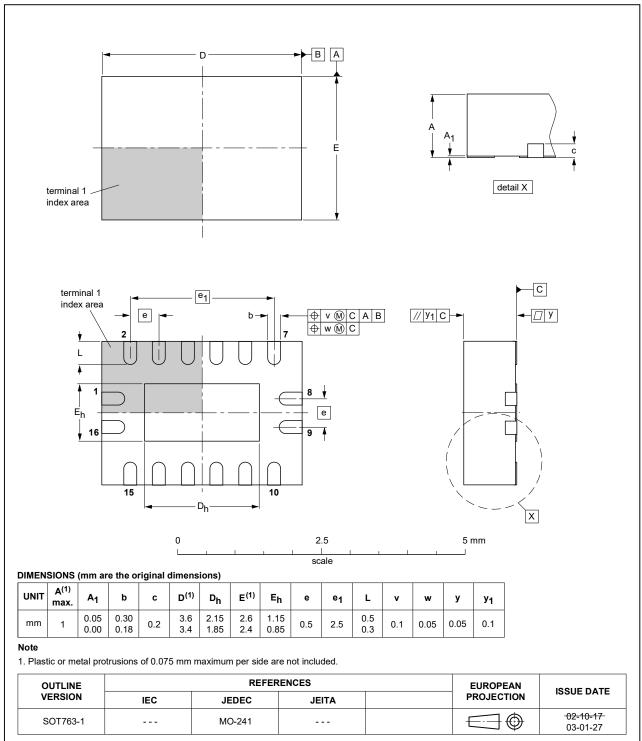


Fig. 13. Package outline SOT763-1 (DHVQFN16)

### 13. Abbreviations

#### **Table 9. Abbreviations**

Acronym	Description
CMOS	Complementary Metal Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic

## 14. Revision history

#### **Table 10. Revision history**

Table 10. Revision history					
Document ID	Release date	Data sheet status	Change notice	Supersedes	
74HC_HCT4040 v.6	20200608	Product data sheet	-	74HC_HCT4040 v.5	
Modifications:	<ul> <li>The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia.</li> <li>Legal texts have been adapted to the new company name where appropriate.</li> <li>Type number 74HC4040DB (SOT338-1/SSOP16) removed.</li> <li>Section 2 updated.</li> <li>Table 4: Derating values for Ptot total power dissipation have been updated.</li> </ul>				
74HC_HCT4040 v.5	20160203	Product data sheet	-	74HC_HCT4040 v.4	
Modifications:	Type numbers 74HC4040N and 74HCT4040N (SOT38-4) removed.				
74HC_HCT4040 v.4	20140320	Product data sheet	-	74HC_HCT4040 v.3	
Modifications:	<ul> <li>The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors.</li> <li>Legal texts have been adapted to the new company name where appropriate.</li> </ul>				
74HC_HCT4040 v.3	20050914	Product data sheet	-	74HC_HCT4040_CNV v.2	
74HC_HCT4040_CNV v.2	19901231	Product specification	-	-	

### 15. Legal information

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Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
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